



Welcome

ODSA Project Workshop at Intel

June 10th, 2019

Consume. Collaborate. Contribute.

Welcome to the OCP ODSA Workshop

Start Time	End Time	Speaker	Company	Topic
8:00 AM	9:00 AM	Registration Intel SC9 Auditorium		
9:00 AM	9:10 AM	Bapi/Animesh	Netronome/Intel	Welcome/Logistics
9:10 AM	9:25 AM	Ahmad Zaidi	Intel	Intel welcome
9:25 AM	10:10 AM	Ramune Nagisetty/Ravi Mahajan (remote)	Intel	Intel chiplets and packaging
10:10 AM	10:30 AM	Animesh Mishra/Robbie Adler	Intel	Virtual Chiplet Platform
10:30 AM	10:45 AM	Break	Sponsored by Intel	
10:45 AM	11:15 AM	Bapi Vinnakota	Netronome	ODSA Technical intro/Progress summary
11:15 AM	11:45 AM	Ramin Farjad/Mark Kuemerle/TBD	Aquantia/Avera Semi	PHY review/BoW interface update
11:45 AM	12:15 PM	David Kehlet	Intel	AIB/Link Layer/Call to Action
12:15 PM	12:30 PM	Surya Bhattacharya	IME Singapore	Advanced packaging for chiplets
12:30 PM	1:15 PM	Lunch	Sponsored by Intel	
1:15 PM	2:20 PM	Panel moderated by Ramune Nagisetty	Intel, AMD, Cisco, eSilicon, Xilinx	Chiplet design experience
2:20 PM	2:40 PM	Jawad Nasrullah/Alex	zGlue/Ayar Labs	CDX - Chiplet Design Exchange + Survey
2:40 PM	3:00 PM	Eugene Chow	Xerox PARC	
3:00 PM	3:15 PM	Break	Sponsored by Intel	
3:15 PM	4:00 PM	JP/Quinn/Manish/Jawad/Marc/Larry	Cisco/Achronix/zGlue/Samtec/Sarcina	PoC Update
4:00 PM	5:00 PM	Panel moderated by Sam Fuller	NXP, Avera Semi, Ayar Labs, Facebook, Granite River Labs, Kandou	Chiplet workflow experience

Thank you Intel, Ahmad Zaidi, Logistics: Cynthia Cobb, Esteri Hinman, Animesh Mishra, Shivani Sud, Preetam Verma

OCP: Kali Burdette, Archana Haylock, Dharmesh Jani, Michael Schill, Dirk van Slyke

Netronome: Sujal Das, Jim Finnegan, Jennifer Mendola, Brian Sparks